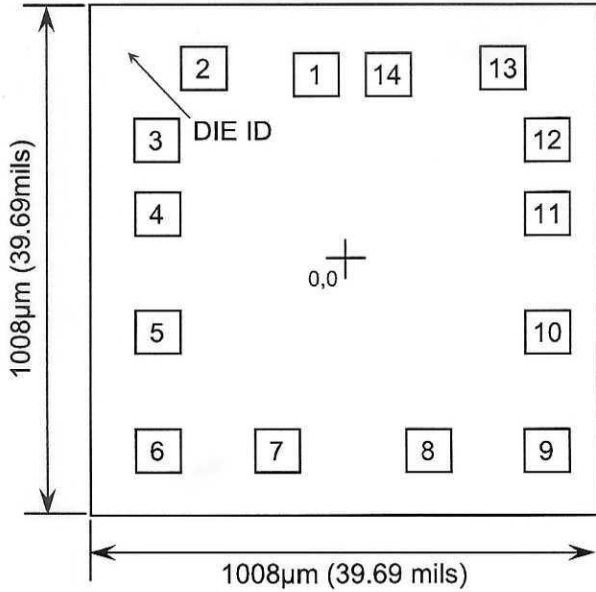




Sierra Components, Inc.

2222 Park Place, 3-E • Minden, Nevada 89423

Phone: 775.783.4940 Fax: 775.783.4947



PAD	FUNCTION	COORDINATES (µm)	
		X	Y
1	OUTPUT 2	-57	391
2	OUTPUT 1	-299	405
3	V _{CC}	-398.5	251
4	-INPUT 1	-396.5	97
5	+INPUT 1	-396.5	-155
6	-INPUT 2	-395	-405
7	+INPUT 2	-143	-405
8	-INPUT 3	179.5	-405
9	+INPUT 3	431.5	-405
10	-INPUT 4	433	-155
11	+INPUT 4	433	97
12	GND	435	251
13	OUTPUT 4	339.5	405
14	OUTPUT 3	97	391

CHIP BACK POTENTIAL IS GND OR FLOAT

Topside Metal: (AL 1% Si 1uM)

Backside Metal: (Si)

Backside Potential: GND or FLOAT

Bond Pad Size: 3.7 Mils min

Mask Ref:

APPROVED BY: MG

DIE SIZE: 40 x 40 Mils

DATE: 6/21/23

MFG: Silicon Supplies

THICKNESS: 11 Mils

P/N: LM239